

Product Compliance Declaration

Please see www.molex.com for the most up-to-date information.

Contact Information

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

Part Information

Part Number 0353621050 Part Weight 0.544G

Part Name WAFER 353621050

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
WAFER 353621050	Assembly		100	0.544
2.0 W/B CONN.WAFER ST	Component		74.2647	0.404
PA66-FR(30)	Material		74.2647	0.404
PA66	Substance		64.0533	0.34845
Flame Retardant, ISO 1043-4 FR(30)	Substance		5.9412	0.03232
Further Additives, not to declare	Substance	system	0.7426	0.00404
Pigment portion, not to declare	Substance	system	0.557	0.00303
Antimonytrioxide	Substance	1309-64-4	2.9706	0.01616
0.5 SQ 8.8mm WIRE PIN PLATED	Assembly		25.7353	0.14
0.5 SQ 8.8mm WIRE PIN UN-PLATED	Component		25.7353	0.14
Yellow Brass 66% Unplated	Material		25.7353	0.14
Copper	Substance	7440-50-8	17.0496	0.09275
Zinc (metal)	Substance	7440-66-6	8.6857	0.04725

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Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2021)4569-DC (8 July 2021)

Contained Substances Exceeding Threshold

None

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Lead	C2680	*Note	250	Yes
Antimonytrioxide	PA66-FR(30)	*Note	50,000	Yes
copper	C2680	*Note	660,000	Yes

^{*}Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Exemptions

Part Name	Exemption
C2680	44 Concentration within acceptable GADSL limits

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HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

None

China ROHS Declaration Information

Part Number	0353621050								
Part Name	WAFER	353621050	(e)						
Part Informatio	n				Haz	zardous S	Substance	es	
Components				Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
WAFER	35362	1050		0	0	0	0	0	0
0.014//0.004	INLAWATED OT				_	_			

2.0 W/B CONN.WAFER ST	0	0	0	0	0	0
0.5 SQ 8.8mm WIRE PIN PLATED	0	0	0	0	0	0
0.5 SQ 8.8mm WIRE PIN UN-PLATED	0	0	0	0	0	0

Additional Information

Annex XVII to REACH (76/769/EEC)	Compliant
Regulation (EU) 2019/1021 (POP)	Compliant

Process Information

Component Plating / Surface Finish	MSn
Termination Base Alloy	Brass
Solder Alloy	SnAgCu
Process Capability	N/A
Maximum Exposure Time (seconds)	N/A
Maximum Process Temperature (C)	N/A

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Maximum Cycles at Reflow Temperature	N/A
J-STD-020 Moisture Sensitivity Level	N/A

Dec 23, 2021